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# FCH47N60

## N-Channel SuperFET® MOSFET

600 V, 47 A, 70 mΩ

### Features

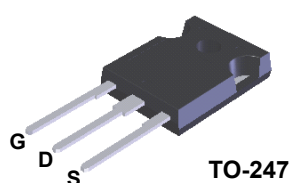
- 650 V @  $T_J = 150^\circ\text{C}$
- Typ.  $R_{DS(on)} = 58\text{ m}\Omega$
- Ultra Low Gate Charge (Typ.  $Q_g = 210\text{ nC}$ )
- Low Effective Output Capacitance (Typ.  $C_{oss(eff.)} = 420\text{ pF}$ )
- 100% Avalanche Tested
- RoHS Compliant

### Applications

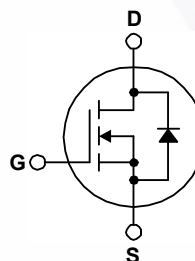
- Solar Inverter
- AC-DC Power Supply

### Description

SuperFET® MOSFET is Fairchild Semiconductor's first generation of high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This technology is tailored to minimize conduction loss, provide superior switching performance,  $dv/dt$  rate and higher avalanche energy. Consequently, SuperFET MOSFET is very suitable for the switching power applications such as PFC, server/telecom power, FPD TV power, ATX power and industrial power applications.



TO-247



### MOSFET Maximum Ratings $T_C = 25^\circ\text{C}$ unless otherwise noted.

| Symbol         | Parameter  |  | FCH47N60_F133 | Unit                |
|----------------|--|--|---------------|---------------------|
| $V_{DSS}$      | Drain to Source Voltage  |  | 600           | V                   |
| $I_D$          | Drain Current  | Continuous ( $T_C = 25^\circ\text{C}$ )  | 47            | A                   |
|                |  | Continuous ( $T_C = 100^\circ\text{C}$ ) | 29.7          |                     |
| $I_{DM}$       | Drain Current  | Pulsed (Note 1)                          | 141           | A                   |
| $V_{GSS}$      | Gate to Source Voltage   |  | $\pm 30$      | V                   |
| $E_{AS}$       | Single Pulsed Avalanche Energy                                       |  | 1800          | mJ                  |
| $I_{AR}$       | Avalanche Current  |  | 47            | A                   |
| $E_{AR}$       | Repetitive Avalanche Energy  |  | 41.7          | mJ                  |
| $dv/dt$        | Peak Diode Recovery $dv/dt$  |  | 4.5           | V/ns                |
| $P_D$          | Power Dissipation  | ( $T_C = 25^\circ\text{C}$ )             | 417           | W                   |
|                |  | Derate Above $25^\circ\text{C}$          | 3.33          | W/ $^\circ\text{C}$ |
| $T_J, T_{STG}$ | Operating and Storage Temperature Range                              |  | -55 to +150   | $^\circ\text{C}$    |
| $T_L$          | Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds |  | 300           | $^\circ\text{C}$    |

### Thermal Characteristics

| Symbol          | Parameter                                     | FCH47N60_F133 | Unit               |
|-----------------|---|---------------|--------------------|
| $R_{\theta JC}$ | Thermal Resistance, Junction to Case, Max.    | 0.3           | $^\circ\text{C/W}$ |
| $R_{\theta JA}$ | Thermal Resistance, Case-to-Sink, Typ.        | 0.24          | $^\circ\text{C/W}$ |
| $R_{\theta JA}$ | Thermal Resistance, Junction to Ambient, Max. | 41.7          | $^\circ\text{C/W}$ |

## Package Marking and Ordering Information

| Part Number   | Top Mark | Package | Packing Method | Reel Size | Tape Width | Quantity |
|---------------|----------|---------|----------------|-----------|------------|----------|
| FCH47N60_F133 | FCH47N60 | TO-247  | Tube           | N/A       | N/A        | 30 units |

## Electrical Characteristics $T_C = 25^\circ\text{C}$ unless otherwise noted.

| Symbol | Parameter | Test Conditions | Min. | Typ. | Max. | Unit |
|--------|-----------|-----------------|------|------|------|------|
|--------|-----------|-----------------|------|------|------|------|

### Off Characteristics

|                                |   |  |     |     |           |                                 |
|--------------------------------|---|--|-----|-----|-----------|---------------------------------|
| $BV_{DSS}$                     | Drain-to-Source Breakdown Voltage           | $V_{GS} = 0\text{ V}, I_D = 250\text{ }\mu\text{A}, T_C = 25^\circ\text{C}$  | 600 | -   | -         | V                               |
|                                |   | $V_{GS} = 0\text{ V}, I_D = 250\text{ }\mu\text{A}, T_C = 150^\circ\text{C}$ | -   | 650 | -         | V                               |
| $\Delta BV_{DSS} / \Delta T_J$ | Breakdown Voltage Temperature Coefficient   | $I_D = 250\text{ }\mu\text{A}$ , Referenced to $25^\circ\text{C}$            | -   | 0.6 | -         | $^\circ\text{V}/^\circ\text{C}$ |
| $BV_{DS}$                      | Drain to Source Avalanche Breakdown Voltage | $V_{GS} = 0\text{ V}, I_D = 47\text{ A}$                                     | -   | 700 | -         | V                               |
| $I_{DSS}$                      | Zero Gate Voltage Drain Current             | $V_{DS} = 600\text{ V}, V_{GS} = 0\text{ V}$                                 | -   | -   | 1         | $\mu\text{A}$                   |
|                                |   | $V_{DS} = 480\text{ V}, T_C = 125^\circ\text{C}$                             | -   | -   | 10        |                                 |
| $I_{GSS}$                      | Gate-to-Body Leakage Current                | $V_{GS} = \pm 30\text{ V}, V_{DS} = 0\text{ V}$                              | -   | -   | $\pm 100$ | nA                              |

### On Characteristics

|              |                                      |   |     |       |       |          |
|--------------|--------------------------------------|---|-----|-------|-------|----------|
| $V_{GS(th)}$ | Gate Threshold Voltage               | $V_{GS} = V_{DS}, I_D = 250\text{ }\mu\text{A}$ | 3.0 | -     | 5.0   | V        |
| $R_{DS(on)}$ | Static Drain-to-Source On Resistance | $V_{GS} = 10\text{ V}, I_D = 23.5\text{ A}$     | -   | 0.058 | 0.070 | $\Omega$ |
| $g_{FS}$     | Forward Transconductance             | $V_{DS} = 40\text{ V}, I_D = 23.5\text{ A}$     | -   | 40    | -     | S        |

### Dynamic Characteristics

|                 |                              |  |   |      |      |    |
|-----------------|------------------------------|--|---|------|------|----|
| $C_{iss}$       | Input Capacitance            | $V_{DS} = 25\text{ V}, V_{GS} = 0\text{ V}, f = 1.0\text{ MHz}$  | - | 5900 | 8000 | pF |
| $C_{oss}$       | Output Capacitance           |  | - | 3200 | 4200 | pF |
| $C_{rss}$       | Reverse Transfer Capacitance |  | - | 250  | -    | pF |
| $C_{oss}$       | Output Capacitance           | $V_{DS} = 480\text{ V}, V_{GS} = 0\text{ V}, f = 1.0\text{ MHz}$ | - | 160  | -    | pF |
| $C_{oss(eff.)}$ | Effective Output Capacitance | $V_{DS} = 0\text{ V to } 400\text{ V}, V_{GS} = 0\text{ V}$      | - | 420  | -    | pF |

### Switching Characteristics

|              |                               |  |   |     |      |    |
|--------------|-------------------------------|--|---|-----|------|----|
| $t_{d(on)}$  | Turn-On Delay                 | $V_{DD} = 300\text{ V}, I_D = 47\text{ A}, V_{GS} = 10\text{ V}, R_G = 25\text{ }\Omega$ | - | 185 | 430  | ns |
| $t_r$        | Turn-On Rise Time             |  | - | 210 | 450  | ns |
| $t_{d(off)}$ | Turn-Off Delay                |  | - | 520 | 1100 | ns |
| $t_f$        | Turn-Off Fall Time            |  | - | 75  | 160  | ns |
| $Q_{g(tot)}$ | Total Gate Charge at 10 V     | $V_{DS} = 480\text{ V}, I_D = 47\text{ A}, V_{GS} = 10\text{ V}$                         | - | 210 | 270  | nC |
| $Q_{gs}$     | Gate to Source Gate Charge    |  | - | 38  | -    | nC |
| $Q_{gd}$     | Gate to Drain "Miller" Charge |  | - | 110 | -    | nC |

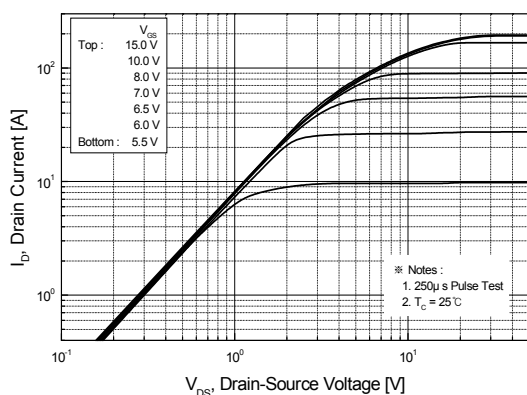
### Drain-Source Diode Characteristics

|                 |  |  |   |     |     |    |
|-----------------|--|--|---|-----|-----|----|
| I <sub>S</sub>  | Maximum Continuous Drain-to-Source Diode Forward Current | -  | - | 47  | A   |    |
| I <sub>SM</sub> | Maximum Pulsed Drain-to-Source Diode Forward Current     | -  | - | 141 | A   |    |
| V <sub>SD</sub> | Drain-to-Source Diode Forward Voltage                    | V <sub>GS</sub> = 0 V, I <sub>SD</sub> = 47 A                                    | - | -   | 1.4 | V  |
| t <sub>rr</sub> | Reverse-Recovery Time                                    | V <sub>GS</sub> = 0 V, I <sub>SD</sub> = 47 A,<br>dI <sub>F</sub> /dt = 100 A/μs | - | 590 | -   | ns |
| Q <sub>rr</sub> | Reverse-Recovery Charge                                  |  | - | 25  | -   | μC |

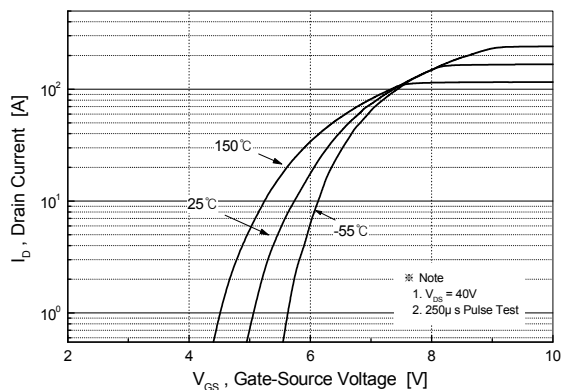
#### Notes:

1. Repetitive rating; pulse-width limited by maximum junction temperature.
2.  $I_{AS} = 18\text{ A}, V_{DD} = 50\text{ V}, R_G = 25\text{ }\Omega$ , starting  $T_J = 25^\circ\text{C}$ .
3.  $I_{SD} \leq 48\text{ A}, di/dt \leq 200\text{ A}/\mu\text{s}, V_{DD} \leq BV_{DSS}$ , starting  $T_J = 25^\circ\text{C}$ .
4. Essentially independent of operating temperature.

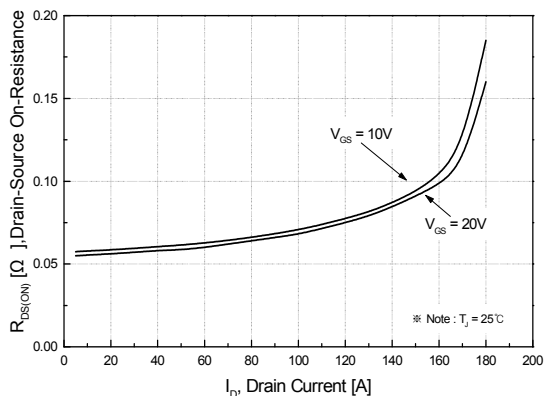
## Typical Performance Characteristics



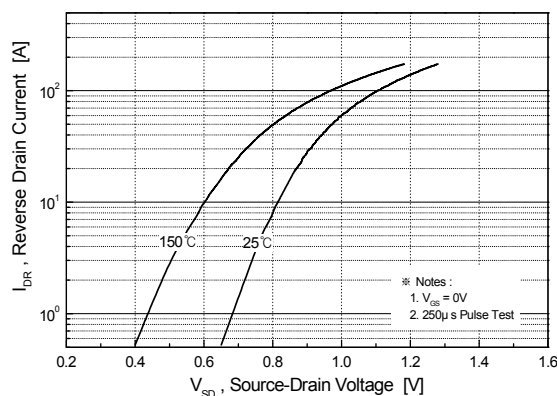
**Figure 1. On-Region Characteristics**



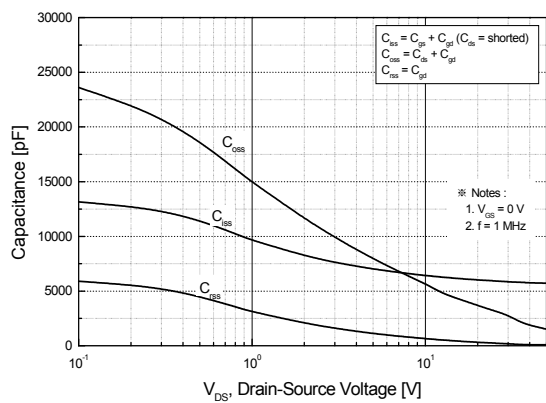
**Figure 2. Transfer Characteristics**



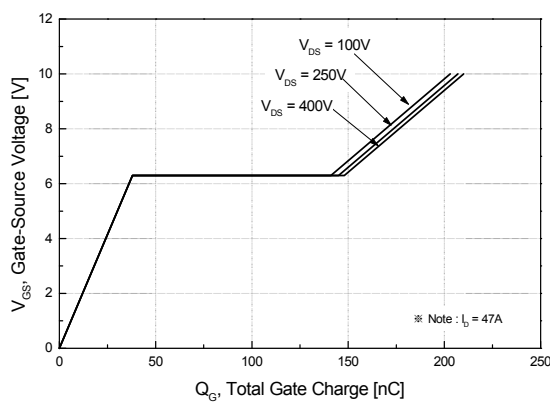
**Figure 3. On-Resistance Variation vs. Drain Current and Gate Voltage**



**Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature**

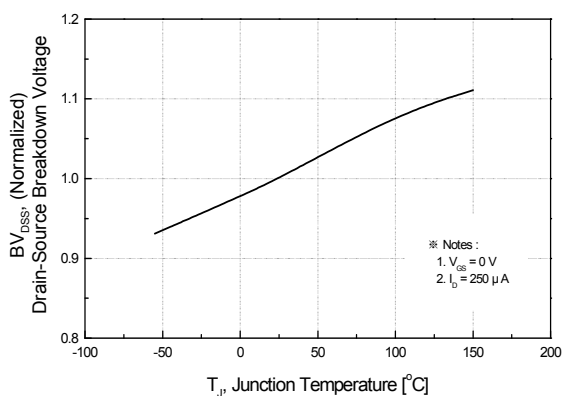


**Figure 5. Capacitance Characteristics**

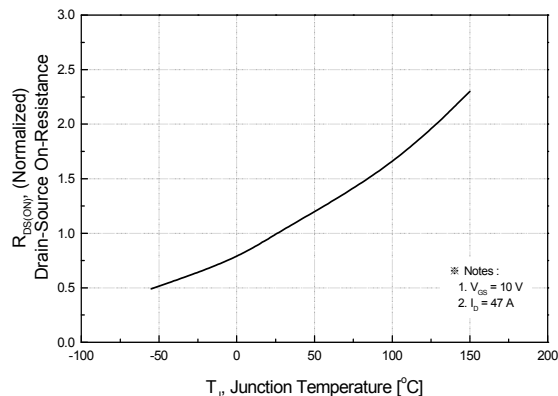


**Figure 6. Gate Charge Characteristics**

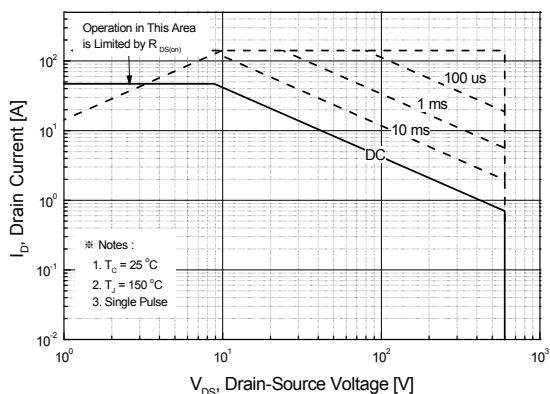
# Typical Performance Characteristics (Continued)



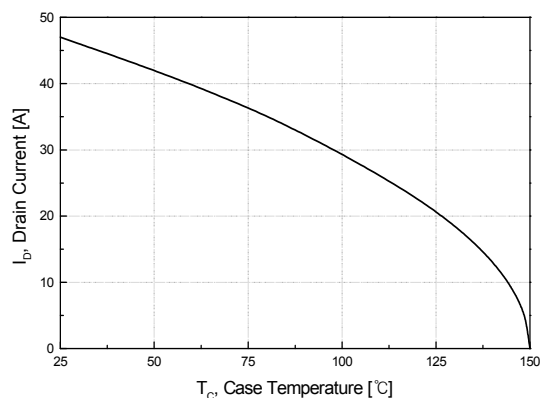
**Figure 7. Breakdown Voltage Variation vs. Temperature**



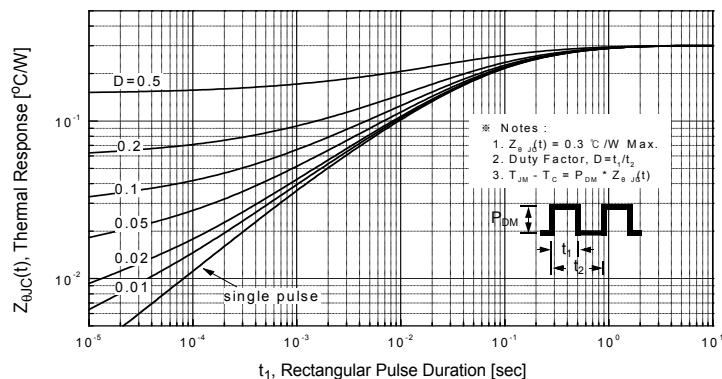
**Figure 8. On-Resistance Variation vs. Temperature**



**Figure 9. Safe Operating Area**



**Figure 10. Maximum Drain Current vs. Case Temperature**



**Figure 11. Transient Thermal Response Curve**



Figure 13. Gate Charge Test Circuit & Waveform



Figure 14. Resistive Switching Test Circuit & Waveforms

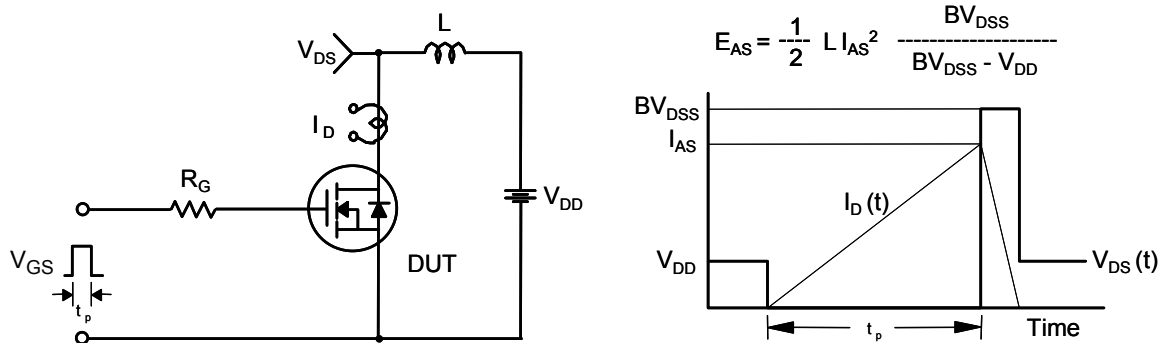
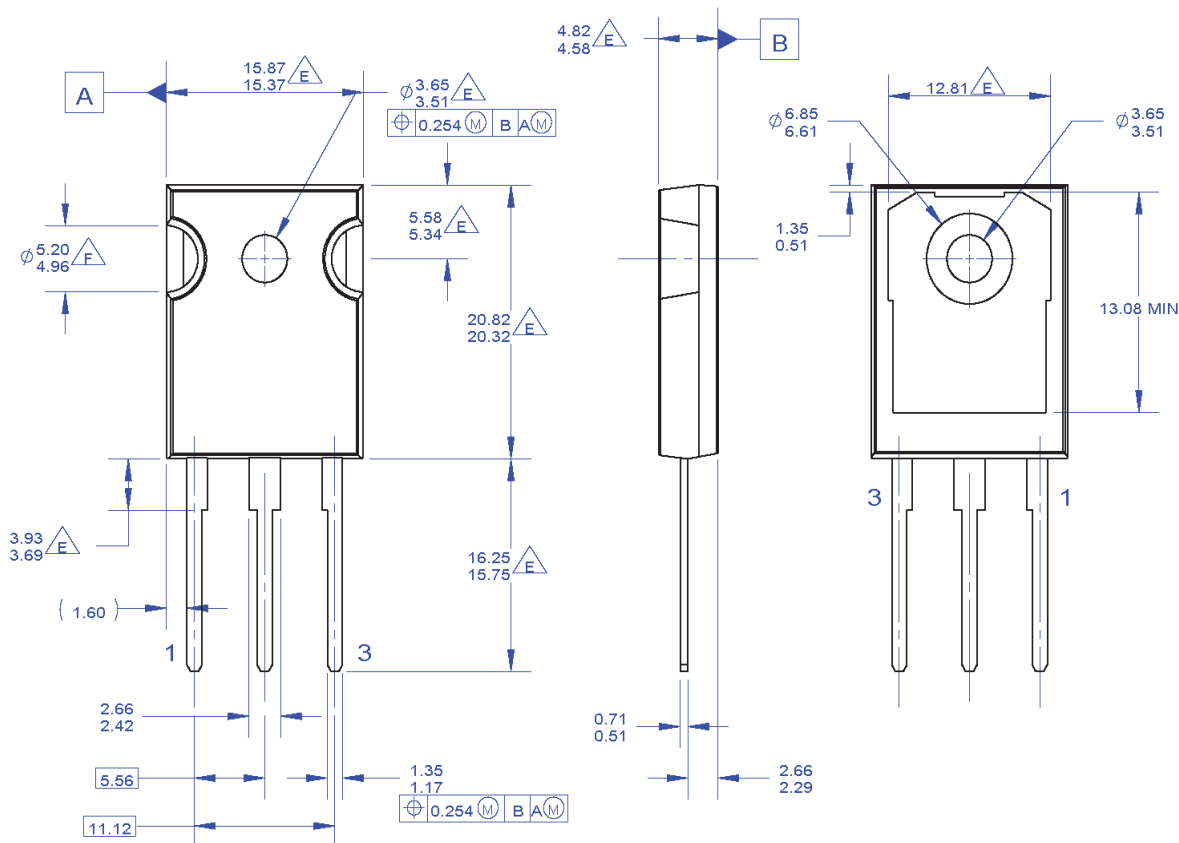


Figure 15. Unclamped Inductive Switching Test Circuit & Waveforms



Figure 16. Peak Diode Recovery  $dv/dt$  Test Circuit & Waveforms

## Mechanical Dimensions



NOTES: UNLESS OTHERWISE SPECIFIED.

- A. PACKAGE REFERENCE: JEDEC TO-247, ISSUE E, VARIATION AB, DATED JUNE, 2004.
- B. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS.
- C. ALL DIMENSIONS ARE IN MILLIMETERS.
- D. DRAWING CONFORMS TO ASME Y14.5 - 1994

$\triangle E$  DOES NOT COMPLY JEDEC STANDARD VALUE

$\triangle F$  NOTCH MAY BE SQUARE

G. DRAWING FILENAME: MKT-TO247A03\_REV03

**Figure 17. TO-247, Molded, 3-Lead, Jedec Variation AB**

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